# 2SD1821A

### Silicon NPN epitaxial planar type

For high breakdown voltage low-frequency and low-noise amplification

#### Features

- $\bullet$  High collector-emitter voltage (Base open)  $V_{CEO}$
- Low noise voltage NV
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing.

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	185	V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	185	V	
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	5	V	
Collector current	I <sub>C</sub>	50	mA	
Peak collector current	I <sub>CP</sub>	100	mA	
Collector power dissipation	P <sub>C</sub>	150	mW	
Junction temperature	Tj	150	°C	
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	

- Package
- Code
- SMini3-G1
- Pin Name
  - 1. Base
  - 2. Emitter
  - 3. Collector
- Marking Symbol: L

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = 100 \ \mu A, I_{\rm B} = 0$	185			V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_{\rm E} = 10 \ \mu {\rm A}, \ I_{\rm C} = 0$	5			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 100 \text{ V}, I_E = 0$			1	μΑ
Forward current transfer ratio *	h <sub>FE</sub>	$V_{CE} = 5 \text{ V}, I_C = 10 \text{ mA}$	130		330	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 30 \text{ mA}, I_{\rm B} = 3 \text{ mA}$			1	V
Transition frequency	$f_{T}$	$V_{CB} = 10 \text{ V}, I_E = -10 \text{ mA}, f = 200 \text{ MHz}$		150		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		2.3		pF
Noise voltage	NV	$V_{CB} = 10 \text{ V}, I_C = 1 \text{ mA}, G_V = 80 \text{ dB},$ $R_g = 100 \text{ k}\Omega, \text{ Function} = \text{FLAT}$		150		mV

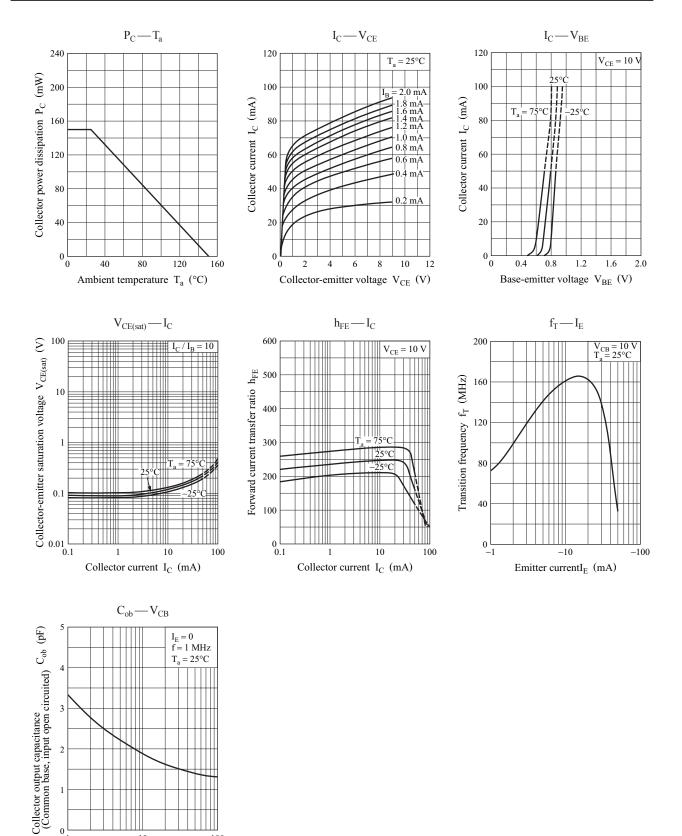
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Rank classification

Rank	R	S
h <sub>FE</sub>	130 to 220	185 to 330

#### 2SD1821A

### **Panasonic**



100

10 Collector-base voltage  $V_{CB}$  (V)

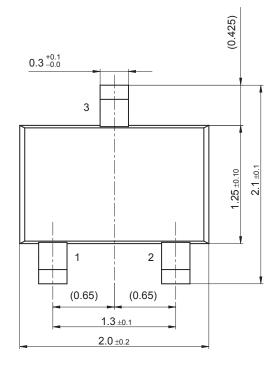
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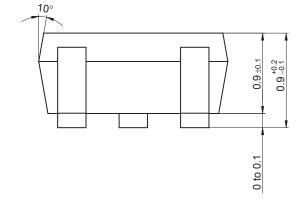
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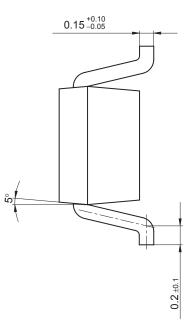
### **Panasonic**

### SMini3-G1

Unit: mm







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